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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF

Cella et al.

FOR

TELECHELIC EMISSIVE OLIGIOMERS

AND POLYMERS DERIVED

THEREFROM

SERIAL NO.

10/680,470

FILED

October 7, 2003

ART UNIT

1711

ATTORNEY DOCKET NO.

GCRZ 2 00013

INFORMATION DISCLOSURE STATEMENT UNDER 37 C.F.R. § 1.97(c)

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

In accordance with 37 C.F.R. §§ 1.56, 1.97, 1.98 and MPEP § 609, Applicant submits the following Disclosure Statement concerning art of which the Applicant is aware. A copy of PTO-1449 is enclosed herewith.

This Information Disclosure Statement is not intended to constitute an admission that any patent, publication or other information referred to herein or submitted herewith is "prior art" for this invention unless specifically designated as such.

In accordance with 37 C.F.R. §1.97(g) and (h), the filing of this Information Disclosure Statement shall not be construed to mean that a search has been made or that no other material information as defined in 37 C.F.R. §1.56(b) exists.

Under § 1.98(a)(3), no concise explanation of relevance is required for information that is in the English language.

5,247,190 - Friend et al.

5,041,514 - Webb et al.

CERTIFICATE OF MAILING

I hereby certify that this INFORMATION DISCLOSURE STATEMENT is being deposited with the United States Postal Service as FIRST CLASS MAIL in an envelope addressed to the Commissioner for Patents, Alexandria, VA 22313-1450, on June 11, 2004.

Nancy M. Grams

Other Art

Sherf et al., Semiconducting Polyfluorenes - Towards Reliable Structure - Property Relationships, Adv. Mater. 2002, 14, No. 7, April 4.

Bernius et al., Progress with Light-Emitting Polymers, Adv. Mater 2000, 12, No. 23, December 1.

Schmitt et al., Conjugated Polyfluorene/Polyaniline Block Copolymers, Macromol. Rapid Commun. 2001, 22, No. 8, pp. 624-628.

Sherf et al., Improving the Performance of Polyfluorene-Based Organic Light-Emitting Diodes via End-Capping, Adv. Mater 2001, 13, No. 8, April 18, pp 565-570.

Under Rule 97(b)(3), this information disclosure statement is being filed before the mailing date of a first Office Action on the merits and accordingly no fee is necessary.

OG Notice August 5, 2003

The Office has waived the requirement under 37 CFR §1.98(a)(2)(i) that copies of cited U.S. patent documents be submitted in connection with all applications filed on or after June 30, 2003. As such, copies of the U.S. patent documents cited herein have not been included.

It is respectfully requested that the attached documents be considered and officially cited in examination of this application.

Respectfully submitted,

FAY, SHARPE, FAGAN, MINNICH & McKEE, LLP

Date: June 11,2004

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Atty. Docket No.: GCRZ 2 00013 Serial No.: 10/680,470

Applicant(s): Cella et al.

Filing Date: October 7, 2003 Group: 1711

Initial*		Document No.	Date	Name	Class	Subcl.	Filing Date
	AA	5,247,190	21SE1993	Friend et al.			
	AB	5,041,514	20AU1991	Webb et al.			
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EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if in conformance and not considered. Include copy of this form with next communication to applicant.